Product data sheet

#### **Product profile** 1.

#### 1.1 General description

The KMA210 is a magnetic angle sensor module. The MagnetoResistive (MR) sensor bridges, the mixed signal Integrated Circuit (IC) and the required capacitances are integrated into a single package.

This angular measurement module KMA210 is pre-programmed, pre-calibrated and therefore, ready to use.

The KMA210 allows user-specific adjustments of angular range, zero angle and clamping voltages. The settings are stored permanently in a non-volatile memory.

#### 1.2 Features and benefits

- High precision sensor for magnetic angular measurement
- Single package sensor module with integrated filters for improved ElectroMagnetic Compatibility (EMC)
- Automotive qualified in accordance with
   Overvoltage protection up to 16 V AEC-Q100 Rev-G
- Programmable user adjustments, including zero angle and angular range
- Fail-safe non-volatile memory with write User-programmable 32-bit identifier protection using lock bit
- Independent from magnetic field strength above 35 kA/m
- Ready to use without external components

- High temperature range up to 160 °C
- Ratiometric analog output voltage
- Programming via One-Wire Interface (OWI)
- Magnet-loss, power-loss and broken bond wire detection
- Factory calibrated



#### Programmable angle sensor

## 2. Pinning information

Table 1. Pinning

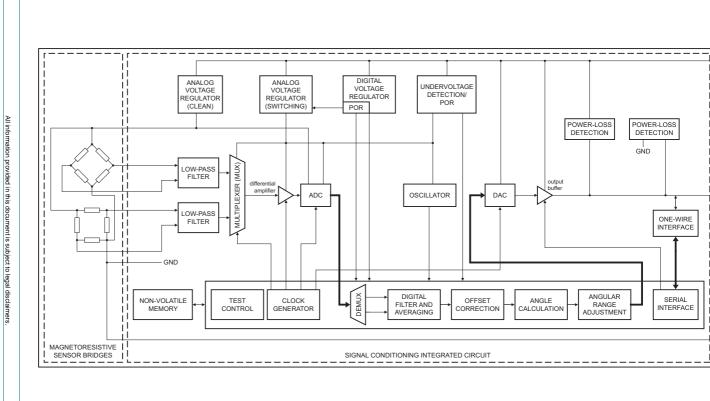
| Table | 1. Pinning |                                 |                    |
|-------|------------|---------------------------------|--------------------|
| Pin   | Symbol     | Description                     | Simplified outline |
| 1     | $V_{DD}$   | supply voltage                  |                    |
| 2     | GND        | ground                          |                    |
| 3     | OUT/DATA   | analog output or data interface |                    |

## 3. Ordering information

Table 2. Ordering information

| Type number | Package |   |         |  |  |  |
|-------------|---------|---|---------|--|--|--|
|             | Name    | Description   | Version |  |  |  |
| KMA210      | -       | plastic single-ended multi-chip package;<br>6 interconnections; 3 in-line leads | SOT1288 |  |  |  |

KMA210



**Functional diagram of KMA210** Fig 1.

Programmable angle sensor

### 5. Functional description

The KMA210 amplifies two orthogonal differential signals from MR sensor bridges and converts them into the digital domain. The angle is calculated using the COordinate Rotation Digital Computer (CORDIC) algorithm. After a digital-to-analog conversion the analog signal is provided to the output as a linear representation of the angular value. Zero angle, clamping voltages and angular range are programmable. In addition, two 16-bit registers are available for customer purposes, such as sample identification.

The KMA210 comprises a Cyclic Redundancy Check (CRC) and an Error Detection and Correction (EDC), as well as magnet-loss and broken bond wire detection to ensure a fail-safe operation. A power-loss detection circuit pulls the analog output to the remaining connection, if either the supply voltage or the ground line of the mixed signal IC is interrupted.

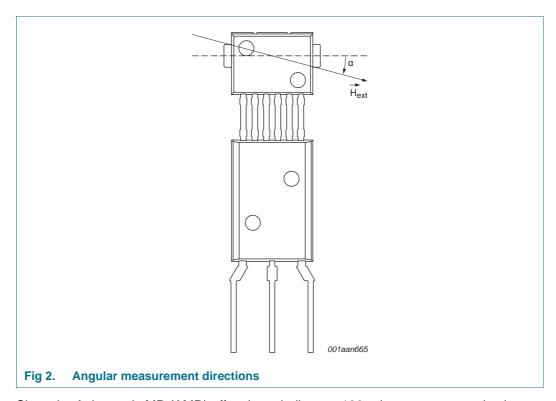
After multiplexing the two MR Wheatstone bridge signals and their successive amplification, the signal is converted into the digital domain by an Analog-to-Digital Converter (ADC). Further processing is done within an on-chip state machine. This includes offset cancellation, calculation of the mechanical angle using the CORDIC algorithm, as well as zero angle and angular range adjustment. The internal Digital-to-Analog Converter (DAC) and the analog output stage are used for conversion of the angle information into an analog output voltage, which is ratiometric to the supply voltage.

The configuration parameters are stored in a user-programmable non-volatile memory. The OWI (accessible using pin OUT/DATA) is used for accessing the memory. In order to protect the memory content a lock bit can be set. After locking the non-volatile memory, its content cannot be changed anymore.

#### 5.1 Angular measurement directions

The differential signals of the MR sensor bridges depend only on the direction of the external magnetic field strength  $H_{\text{ext}}$ , which is applied parallel to the plane of the sensor. In order to obtain a correct output signal, the minimum saturation field strength has to be exceeded.

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Since the Anisotropic MR (AMR) effect is periodic over  $180^{\circ}$ , the sensor output is also  $180^{\circ}$ -periodic, where the angle is calculated relative to a freely programmable zero angle. The dashed line indicates the mechanical zero degree position.

## 6. Analog output

The KMA210 provides one analog output signal on pin OUT/DATA. The measured angle  $\alpha$  is converted linearly into a value, which is ratiometric to the supply voltage  $V_{DD}$ . Either a positive or a negative slope is provided for this purpose.

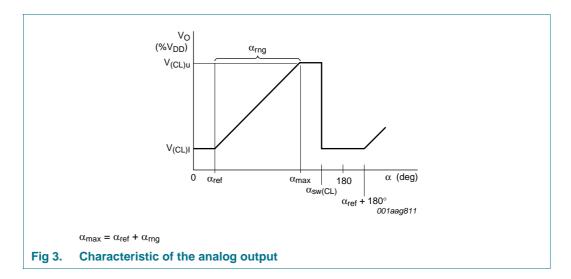
<u>Table 3</u> describes the analog output behavior for a positive slope. If for example, a magnetic field angle, above the programmed maximum angle  $\alpha_{max}$ , but below the clamp switch angle  $\alpha_{sw(CL)}$  is applied to the sensor, then analog output is set to the upper clamping voltage. If the magnetic field angle is larger than the clamp switch angle, the analog output switches from upper to lower clamping voltage. In the case of a negative slope, the clamping voltages are changed.

Table 3. Analog output behavior for a positive slope

| Magnetic field angle  | Analog output |
|---|---------------|
| $\alpha_{\text{max}} < \alpha < \alpha_{\text{sw(CL)}}$         | $V_{(CL)u}$   |
| $\alpha_{\rm SW(CL)} < \alpha < \alpha_{\rm ref} + 180^{\circ}$ | $V_{(CL)I}$   |

The analog output voltage range encodes both angular and diagnostic information. A valid angle value is between the upper and lower clamping voltage. If the analog output is in the diagnostic range, that is below 4  $\rm \%V_{DD}$  or above 96  $\rm \%V_{DD}$ , an error condition has been detected. The analog output repeats every 180°.

#### Programmable angle sensor



## 7. Diagnostic features

The KMA210 provides several diagnostic features:

#### 7.1 CRC and EDC supervision

The KMA210 includes a supervision of the programmed data. At power-on, a CRC of the non-volatile memory is performed. Furthermore the memory is protected against bit errors. Every 16-bit data word is saved internally as a 22-bit word for this purpose. The protection logic corrects any single-bit error in a data word, while the sensor continues in normal operation mode. Double-bit errors per word will be detected and switches the device into diagnostic mode.

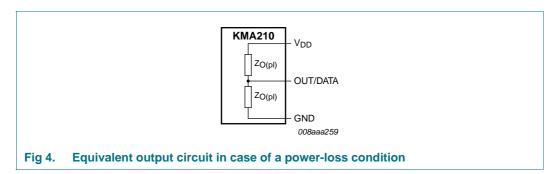
#### 7.2 Magnet-loss detection

If the applied magnetic field strength is not sufficient, the KMA210 can raise a diagnostic condition. In order to enter the diagnostic mode, due to magnet-loss, the detection has to be enabled first. The device can be programmed into active diagnostic mode, where the output is driven below 4  $\%V_{DD}$  or above 96  $\%V_{DD}$ .

#### 7.3 Power-loss detection

The power-loss detection circuit enables the detection of an interrupted supply or ground line of the mixed signal IC in normal operation mode up to the maximum operating supply voltage. In the case of a power-loss condition, two internal switches in the sensor are closed, connecting the pin of the analog output to the supply voltage and the ground pins.

#### Programmable angle sensor



<u>Table 4</u> describes the power-loss behavior and gives the resulting output voltage depending on the interrupted supply or ground line and the load resistance.

Table 4. Power-loss behavior

| Load resistance                  | Interrupted supply line | Interrupted ground line |
|----------------------------------|-------------------------|-------------------------|
| $R_{L(ext)} > 5 \text{ k}\Omega$ | $V_O \le 4 \% V_{DD}$   | $V_O \ge 96  \%V_{DD}$  |

#### 7.4 Broken bond wire detection

The broken bond wire detection circuit enables the detection of an interrupted supply or ground line of the MR sensor bridge. In the case of a broken bond wire the device goes into diagnostic mode and a status bit is set.

#### 7.5 Low supply voltage detection and overvoltage protection

If the supply voltage is below the switch-off threshold voltage, a status bit is set and the device goes into diagnostic mode. If the supply voltage is above the overvoltage switch-on threshold voltage, the device enters diagnostic mode. <u>Table 5</u> describes the system behavior depending on the voltage range of the supply voltage.

Table 5. System behavior

| Supply voltage                                    | State                | Description   |
|---|----------------------|---|
| 0 V to $\cong$ 1.8 V                              | start-up power       | The output buffer drives an active LOW or is powered down, but the switches of the power-loss detection circuit are not fully opened and set the output to a level between ground and half the supply voltage.  |
| $\cong$ 1.8 V to $V_{POR}$                        | power-on<br>reset    | The power-loss charge pump is fully operational and turns the switches of the detection circuit off. The output buffer drives an active LOW and sets the output to the lower diagnostic level. During the reset phase all circuits are in reset and/or Power-down mode. |
| $V_{POR}$ to $V_{th(on)}$ or $V_{th(off)}$        | initialization       | The digital core and the oscillator are active. After reset the content of the non-volatile memory is copied into the shadow registers. The output buffer drives an active LOW and sets the output to the lower diagnostic level.                                       |
| $V_{th(on)}$ or $V_{th(off)}$ to minimum $V_{DD}$ | functional operation | All analog circuits are active and the measured angle is available at the analog output. Not all parameters are within the specified limits.  |

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Table 5. System behavior ...continued

| Supply voltage   | State                | Description  |
|--|----------------------|--|
| Minimum $V_{DD}$ to maximum $V_{DD}$   | normal<br>operation  | All analog circuits are active and the measured angle is available at the analog output. All parameters are within the specified limits.       |
| $\begin{array}{c} \text{Maximum V}_{\text{DD}} \text{ to} \\ \text{V}_{\text{th(ov)}} \end{array}$ | functional operation | All analog circuits are active and the measured angle is available at the analog output. Not all parameters are within the specified limits.   |
| V <sub>th(ov)</sub> to 16 V  | overvoltage          | The digital core and the oscillator are active but all other circuits are in Power-down mode. The output is set to the lower diagnostic level. |

<u>Table 6</u> describes the diagnostic behavior and the resulting output voltage depending on the error case. Furthermore the duration and termination condition to enter and leave the diagnostic mode are given, respectively.

Table 6. Diagnostic behavior

| Diagnostic condition | Duration          | Analog output  | Termination condition          |
|----------------------|-------------------|--|--------------------------------|
| Low voltage          | 1 μs < t < 10 μs  | $\leq$ 4 % $V_{DD}$  | functional or normal operation |
| Overvoltage          | 1 μs < t < 10 μs  | $\leq$ 4 % $V_{DD}$  | functional or normal operation |
| Checksum error       | n/a               | $\leq 4~\%V_{DD}~or \geq 96~\%V_{DD}^{\hbox{\scriptsize $\underline{\tiny [2]}$}}$ | power-on reset[1]              |
| Double-bit error     | n/a               | $\leq 4~\%V_{DD}~or \geq 96~\%V_{DD}^{\hbox{\scriptsize $\underline{\tiny [2]}$}}$ | power-on reset[1]              |
| Magnet-loss          | 0.5 ms < t < 6 ms | $\leq 4~\%V_{DD}~or \geq 96~\%V_{DD}^{\hbox{\scriptsize [2]}}$                     | magnet present[1]              |
| Power-loss           | ≤ 2 ms            | $\leq 4~\%V_{DD}~or \geq 96~\%V_{DD}^{\hbox{\scriptsize [2]}}$                     | power-on reset                 |
| Broken bond wire     | 0.2 ms < t < 1 ms | $\leq 4~\%V_{DD}~or \geq 96~\%V_{DD}^{\hbox{\scriptsize $\underline{\tiny [2]}$}}$ | power-on reset[1]              |

<sup>[1]</sup> Status bit stays set in command register until power-on reset.

## 8. Limiting values

Table 7. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol                   | Parameter                       | Conditions                                  | Min          | Max  | Unit  |
|--------------------------|---------------------------------|---|--------------|------|-------|
| $V_{DD}$                 | supply voltage                  |   | -0.3         | +16  | V     |
| Vo                       | output voltage                  |   | -0.3         | +16  | V     |
| $V_{O(ov)}$              | overvoltage output voltage      | T <sub>amb</sub> < 140 °C [1]<br>at t < 1 h | $V_{th(ov)}$ | 16   | V     |
| l <sub>r</sub>           | reverse current                 | T <sub>amb</sub> < 70 °C                    | -            | 150  | mA    |
| T <sub>amb</sub>         | ambient temperature             |   | -40          | +160 | °C    |
| T <sub>amb(pr)</sub>     | programming ambient temperature |   | 10           | 70   | °C    |
| T <sub>stg</sub>         | storage temperature             |   | -40          | +125 | °C    |
| Non-volatile             | e memory                        |   |              |      |       |
| t <sub>ret(D)</sub>      | data retention time             | T <sub>amb</sub> = 50 °C                    | 17           | -    | year  |
| $N_{\text{endu}(W\_ER)}$ | write or erase endurance        | T <sub>amb(pr)</sub> = 70 °C                | 100          | -    | cycle |

<sup>[1]</sup> Overvoltage on analog output and supply within the specified operating voltage range.

<sup>[2]</sup> Depending on the diagnostic level setting.

#### Programmable angle sensor

## 9. Recommended operating conditions

Table 8. Operating conditions

In a homogenous magnetic field.

| Symbol               | Parameter                        | Conditions |            | Min | Тур | Max      | Unit |
|----------------------|----------------------------------|------------|------------|-----|-----|----------|------|
| $V_{DD}$             | supply voltage                   |            | <u>[1]</u> | 4.5 | 5.0 | 5.5      | V    |
| T <sub>amb</sub>     | ambient temperature              |            |            | -40 | -   | +160     | °C   |
| T <sub>amb(pr)</sub> | programming ambient temperature  |            |            | 10  | -   | 70       | °C   |
| C <sub>L(ext)</sub>  | external load capacitance        |            | [1][2]     | 0   | -   | 22       | nF   |
|                      |                                  |            | [2][3]     | 0   | -   | 6.8      | nF   |
| R <sub>L(ext)</sub>  | external load resistance         |            | [4]        | 5   | -   | $\infty$ | kΩ   |
| H <sub>ext</sub>     | external magnetic field strength |            |            | 35  | -   | -        | kA/m |

<sup>[1]</sup> Normal operation mode.

#### 10. Thermal characteristics

Table 9. Thermal characteristics

| Symbol        | Parameter                                   | Conditions | Тур | Unit |
|---------------|---|------------|-----|------|
| $R_{th(j-a)}$ | thermal resistance from junction to ambient |            | 145 | K/W  |

#### 11. Characteristics

Table 10. Supply current

Characteristics are valid for the operating conditions, as specified in Section 9.

| Symbol               | Parameter                      | Conditions | Min          | Тур | Max  | Unit |
|----------------------|--------------------------------|------------|--------------|-----|------|------|
| $I_{DD}$             | supply current                 | [1]        | <u>[2]</u> 5 | -   | 10.5 | mA   |
|                      |                                | [3]        | [4] _        | -   | 13   | mA   |
| $I_{\text{off(ov)}}$ | overvoltage switch-off current | <u>.</u>   | [5] _        | -   | 6    | mA   |

<sup>[1]</sup> Normal operation and diagnostic mode excluding overvoltage and undervoltage within the specified operating supply voltage range.

<sup>[2]</sup> Between ground and analog output.

<sup>[3]</sup> Command mode.

<sup>[4]</sup> Power-loss detection is only possible with a load resistance within the specified range connected to the supply or ground line.

<sup>[2]</sup> Without load current at the analog output.

<sup>[3]</sup> Normal operation and diagnostic mode over full voltage range up to limiting supply voltage at steady state.

<sup>[4]</sup> With minimum load resistance at the analog output.

<sup>[5]</sup> Diagnostic mode for a supply voltage above the overvoltage threshold voltage up to the limiting supply voltage.

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**Table 11. Power-on reset**Characteristics are valid for the operating conditions, as specified in <u>Section 9</u>.

| Symbol               | Parameter                      | Conditions  | Min  | Тур  | Max  | Unit |
|----------------------|--------------------------------|---|------|------|------|------|
| $V_{th(on)} \\$      | switch-on threshold voltage    | analog output switches on, if $V_{DD} > V_{th(on)}$   | -    | 4.30 | 4.45 | V    |
| $V_{\text{th(off)}}$ | switch-off threshold voltage   | analog output switches off, if $V_{DD} < V_{th(off)}$ | 3.90 | 4.10 | -    | V    |
| V <sub>hys</sub>     | hysteresis voltage             | $V_{hys} = V_{th(on)} - V_{th(off)}$                  | 0.1  | 0.2  | -    | V    |
| $V_{POR}$            | power-on reset voltage         | IC is initialized                                     | -    | 3.3  | 3.6  | V    |
| $V_{\text{th(ov)}}$  | overvoltage threshold voltage  | analog output switches off, if $V_{DD} > V_{th(ov)}$  | 6.5  | 7.5  | 8.0  | V    |
| V <sub>hys(ov)</sub> | overvoltage hysteresis voltage |   | 0.1  | 0.3  | -    | V    |

Table 12. Module performance

Characteristics are valid for the operating conditions, as specified in Section 9.

| Symbol                                    | Parameter                                   | Conditions   |                  | Min  | Тур | Max  | Unit      |
|---|---|--|------------------|------|-----|------|-----------|
| $\alpha_{\text{res}}$                     | angle resolution                            |  | <u>[1]</u>       | -    | -   | 0.04 | deg       |
| $\alpha_{\text{max}}$                     | maximum angle                               | programmable angular range for $V_{(CL)u} - V_{(CL)I} \ge 80 \ \%V_{DD}$ | [2]              | 5    | -   | 180  | deg       |
| $\alpha_{\text{ref}}$                     | reference angle                             | programmable zero angle  | [2]              | 0    | -   | 180  | deg       |
| $V_{O(nom)}$                              | nominal output voltage                      | at full supply operating range   |                  | 5    | -   | 95   | $%V_{DD}$ |
| $V_{O(udr)}$                              | upper diagnostic range output voltage       |  | [3][4][5]        | 96   | -   | 100  | $%V_{DD}$ |
| $V_{O(Idr)}$                              | lower diagnostic range output voltage       |  | [3][4][5]        | 0    | -   | 4    | $%V_{DD}$ |
| $V_{(CL)u}$                               | upper clamping voltage                      |  | [4][5][6]        | 40   | -   | 95   | $%V_{DD}$ |
| V <sub>(CL)I</sub>                        | lower clamping voltage                      |  | [4][5][6]        | 5    | -   | 30.5 | $%V_{DD}$ |
| $\Delta V_{(CL)}$                         | clamping voltage variation                  | deviation from programmed value  | [4][5]           | -0.3 | -   | +0.3 | $%V_{DD}$ |
| $V_{n(o)(RMS)}$                           | RMS output noise voltage                    | equivalent power noise   | [1][4]           | -    | 0.4 | 2.5  | mV        |
| $\Delta \phi_{lin}$                       | linearity error                             | temperature range<br>–40 °C to +160 °C                                   | [4][7]           | -1.2 | -   | +1.2 | deg       |
|   |   | temperature range<br>-40 °C to +140 °C                                   | [4][7]           | -1   | -   | +1   | deg       |
| $\Delta \phi_{\text{temp}}$               | temperature drift error                     | temperature range<br>-40 °C to +160 °C                                   | [1][4][7]<br>[8] | -    | -   | 0.8  | deg       |
|   |   | temperature range<br>-40 °C to +140 °C                                   | [1][4][7]<br>[8] | -    | -   | 0.65 | deg       |
| $\Delta \phi_{\text{temp}}  _{\text{RT}}$ | temperature drift error at room temperature | temperature range<br>-40 °C to +160 °C                                   | [7][8][9]        | -    | -   | 0.65 | deg       |
|   |   | temperature range<br>-40 °C to +140 °C                                   | [7][8][9]        | -    | -   | 0.55 | deg       |
| $\Delta \phi_{hys}$                       | hysteresis error                            | referred to input  | [4][7]           | -    | -   | 0.09 | deg       |
| $\Delta \phi_{\mu lin}$                   | microlinearity error                        | referred to input  | [4][7]           | -0.1 | -   | +0.1 | deg       |

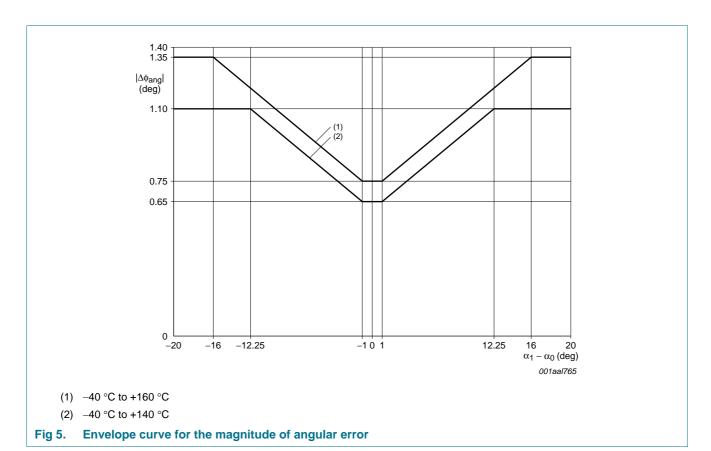
#### Programmable angle sensor

 Table 12.
 Module performance ...continued

Characteristics are valid for the operating conditions, as specified in Section 9.

| Symbol              | Parameter                   | Conditions   | Min                  | Тур | Max   | Unit    |
|---------------------|-----------------------------|--|----------------------|-----|-------|---------|
| $\Delta \phi_{ang}$ | angular error               | temperature range<br>-40 °C to +160 °C   | [4][7] -1.35<br>[10] | -   | +1.35 | deg     |
|                     |                             | temperature range<br>-40 °C to +140 °C   | [4][7] -1.1<br>[10]  | -   | +1.1  | deg     |
| m <sub>ang</sub>    | slope of angular error      |  | [4][7] -<br>[10]     | -   | 0.04  | deg/deg |
| $Z_{O(pl)}$         | power-loss output impedance | impedance to remaining<br>supply line in case of lost<br>supply voltage or lost ground | -                    | -   | 210   | Ω       |

- [1] At a nominal output voltage between 5 %V<sub>DD</sub> and 95 %V<sub>DD</sub> and a maximum angle of  $\alpha_{max}$  = 180°.
- [2] In steps of resolution < 0.022°.
- [3] Activation is dependent on the programmed diagnostic mode.
- [4] At a low-pass filtered analog output with a cut-off frequency of 0.7 kHz.
- [5] Settling to these values is limited by 0.7 kHz low-pass filtering of analog output.
- [6] In steps of 0.02 %V<sub>DD</sub>.
- [7] Definition of errors is given in Section 12.
- [8] Based on a 3σ standard deviation.
- [9] Room temperature is given for an ambient temperature of 25 °C.
- [10] Graph of angular error is shown in Figure 5.



#### Programmable angle sensor

Table 13. Dynamics

Characteristics are valid for the operating conditions, as specified in Section 9.

| Symbol                | Parameter                 | Conditions  | Min | Тур   | Max | Unit |
|-----------------------|---------------------------|---|-----|-------|-----|------|
| t <sub>on</sub>       | turn-on time              | until first valid result  | -   | -     | 5   | ms   |
| f <sub>upd</sub>      | update frequency          |   | 2.4 | 3.125 | -   | kHz  |
| t <sub>s</sub>        | settling time             | after an ideal mechanical<br>angle step of 45°, until 90 %<br>of the final value is reached | -   | -     | 1.8 | ms   |
| t <sub>cmd(ent)</sub> | enter command mode time   | after power on  | 20  | -     | 30  | ms   |
| t <sub>rec(ov)</sub>  | overvoltage recovery time | after overvoltage   | -   | -     | 4   | ms   |

#### Table 14. Digital interface

Characteristics are valid for the operating conditions, as specified in Section 9.

| Conditions $I_{O} = 2 \text{ mA}$ $I_{O} = 2 \text{ mA}$ absolute value for overdriving | Min<br>80<br>-<br>80<br>-   | Typ  | -<br>20  | World WVDD WVDD                                   |
|---|---|--|--|---|
| $I_O = 2 \text{ mA}$  | - 80  | -  | 20   | %V <sub>DD</sub>                                  |
| $I_O = 2 \text{ mA}$  | 80  | -  | -  |   |
| $I_O = 2 \text{ mA}$  |   | -  | -  | 70 V DD   |
|   | -   | -  |  |   |
| absolute value for overdriving  |   |  | 20   | $%V_{DD}$   |
| the output buffer   | -   | -  | 20   | mA  |
| LOW level before rising edge  | 5   | -  | -  | μS  |
| HIGH level before falling edge  | 5   | -  | -  | μS  |
| minimum period may be<br>limited by the load<br>capacitance                             | 10  | -  | 100  | μS  |
| deviation between received clock and sent clock   | 0.8T <sub>bit</sub>   | 1T <sub>bit</sub>  | 1.2T <sub>bit</sub>  | μS  |
|   | $0.175T_{bit}$  | $0.25T_{bit}$  | $0.375T_{bit}$   | μS  |
|   | 0.625T <sub>bit</sub>   | $0.75T_{bit}$  | 0.825T <sub>bit</sub>  | μS  |
| communication reset guaranteed after maximum t <sub>to</sub>                            | -   | -  | 220  | μS  |
| duration of LOW level for slave takeover  | 1   | -  | 5  | μS  |
| duration of LOW level for<br>master takeover  | 0T <sub>bit</sub>   | -  | 0.5T <sub>bit</sub>  | μS  |
| for a single memory address   | 20  | -  | -  | ms  |
| waiting time after enabling the non-volatile memory charge pump clock                   | 1   | -  | -  | ms  |
|   | the output buffer  LOW level before rising edge  HIGH level before falling edge  minimum period may be limited by the load capacitance  deviation between received clock and sent clock  communication reset guaranteed after maximum t <sub>to</sub> duration of LOW level for slave takeover  duration of LOW level for master takeover  for a single memory address waiting time after enabling the non-volatile memory charge | the output buffer  LOW level before rising edge 5  HIGH level before falling edge 5  minimum period may be limited by the load capacitance  deviation between received clock and sent clock 0.175T <sub>bit</sub> communication reset guaranteed after maximum t <sub>to</sub> -  duration of LOW level for slave takeover duration of LOW level for master takeover for a single memory address 20  waiting time after enabling the non-volatile memory charge 10  HIGH level 5  0.8T <sub>bit</sub> 0.625T <sub>bit</sub> -  0.625T <sub>bit</sub> 0.625T <sub>bit</sub> 1 | the output buffer  LOW level before rising edge 5 -  HIGH level before falling edge 5 -  minimum period may be limited by the load capacitance  deviation between received clock and sent clock  0.175T <sub>bit</sub> 0.25T <sub>bit</sub> 0.625T <sub>bit</sub> 0.75T <sub>bit</sub> communication reset guaranteed after maximum t <sub>to</sub> duration of LOW level for slave takeover  duration of LOW level for master takeover  for a single memory address  waiting time after enabling the non-volatile memory charge | the output buffer  LOW level before rising edge 5 |

#### Table 15. Internal capacitances

Characteristics are valid for the operating conditions, as specified in Section 9.

| Symbol             | Parameter            | Conditions | Min           | Тур | Max | Unit |
|--------------------|----------------------|------------|---------------|-----|-----|------|
| C <sub>block</sub> | blocking capacitance |            | <u>[1]</u> 25 | 47  | 75  | nF   |
| C <sub>L</sub>     | load capacitance     |            | <u>11</u> 1.1 | 2.2 | 3.3 | nF   |

<sup>[1]</sup> Measured at 1 MHz.

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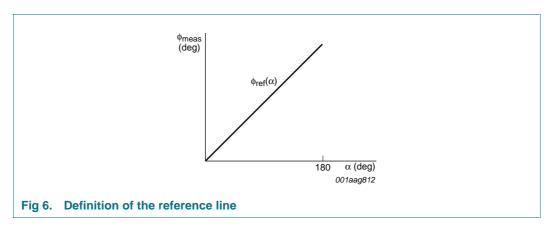
KMA210

Programmable angle sensor

### 12. Definition of errors

#### 12.1 General

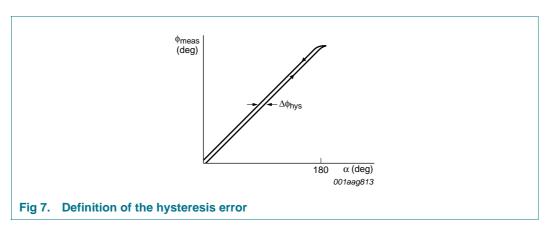
Angular measurement errors by the KMA210 result from linearity errors, temperature drift errors and hysteresis errors. Figure 6 shows the output signal of an ideal sensor, where the measured angle  $\phi_{meas}$  corresponds ideally to the magnetic field angle  $\alpha$ . This curve will further be denoted as angle reference line  $\phi_{ref}(\alpha)$  with a slope of 0.5 %V<sub>DD</sub>/degree.



The angular range is set to  $\alpha_{max}$  = 180° and the clamping voltages are programmed to  $V_{(CL)I}$  = 5 % $V_{DD}$  and  $V_{(CL)u}$  = 95 % $V_{DD}$  for a valid definition of errors.

### 12.2 Hysteresis error

The hysteresis error  $\Delta\phi_{hys}$  is defined as the maximum difference between the angles, given by the device output when performing a positive (clockwise) rotation and negative (counter clockwise) rotation over an angular range of 180°, measured at a constant temperature.



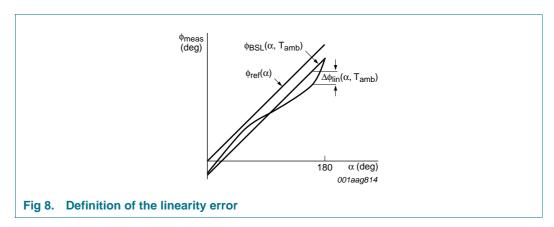
Equation 1 gives the mathematical description for the hysteresis value  $\Delta \phi_{hys}$ :

$$\Delta \phi_{hys}(\alpha) = \left| \phi_{meas}(\alpha \to 180^{\circ}) - \phi_{meas}(\alpha \to 0^{\circ}) \right| \tag{1}$$

#### Programmable angle sensor

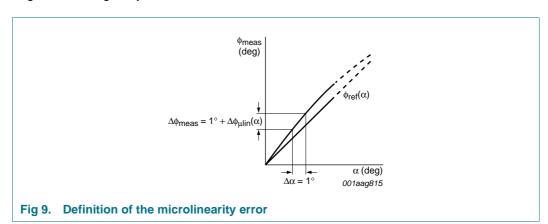
#### 12.3 Linearity error

The KMA210 output signal deviation from a best straight line  $\phi_{BSL}$ , with the same slope as the reference line, is defined as linearity error. The magnetic field angle is varied at fixed temperatures for measurement of this linearity error. The output signal deviation from the best straight line at the given temperature is the linearity error  $\Delta \phi_{lin}$ . It is a function of the magnetic field angle  $\alpha$  and the temperature of the device  $T_{amb}$ .



#### 12.4 Microlinearity error

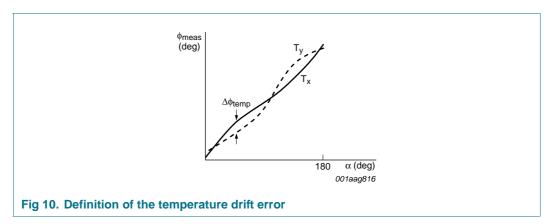
The microlinearity error  $\Delta\phi_{\mu lin}$  is the device output deviation from 1°, if the magnetic field angle  $\alpha$  is changed by  $\Delta\alpha=1^{\circ}$ .



#### 12.5 Temperature drift error

The temperature drift  $\Delta\phi_{temp}$  is defined as the envelope over the deviation of the angle versus the temperature range. It is considered as the pure thermal effect.

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Equation 2 gives the mathematical description for temperature drift value  $\Delta \phi_{temp}$ :

$$\Delta \phi_{temp}(\alpha) = \left| \phi_{meas}(\alpha, T_x) - \phi_{meas}(\alpha, T_y) \right| \tag{2}$$

with:

 $T_x$ : temperature for maximum  $\phi_{meas}$  at angle  $\alpha$ 

 $T_v$ : temperature for minimum  $\phi_{meas}$  at angle  $\alpha$ 

The deviation from the value at room temperature  $\Delta \phi_{\text{temp}}|_{\text{RT}}$  describes the temperature drift of the angle, compared to the value, which the sensor provides at room temperature:

$$\Delta \phi_{temp|RT}(\alpha, T_{amb}) = \left| \phi_{meas}(\alpha, T_{amb}) - \phi_{meas}(\alpha, T_{RT}) \right| \tag{3}$$

with:

T<sub>RT</sub>: room temperature (25 °C)

#### 12.6 Angular error

The angular error  $\Delta\phi_{ang}$  is the error of angle difference measured by the sensor, if the mechanical angle deviates from  $\alpha_0$  to  $\alpha_1$ . Here  $\alpha_0$  and  $\alpha_1$  are arbitrary angles within the angular range. The angle measurement at  $\alpha_0$  is the initially programmed reference angle, programmed by the customer at room temperature and zero hour upon production. The angle measurement at  $\alpha_1$  is made at any temperature within the ambient temperature range:

$$\Delta \phi_{ang} = (\phi_{meas}(\alpha_1, T_{amb}) - \phi_{meas}(\alpha_0, T_{RT})) - (\alpha_1 - \alpha_0) \tag{4}$$

with:

 $\alpha_0$ ,  $\alpha_1$ : arbitrary mechanical angles within the angular range

 $\phi_{\text{meas}}(\alpha_0, T_{\text{RT}})$ : programmed angle at  $\alpha_0, T_{\text{RT}} = 25$  °C and zero hour upon production

 $\phi_{meas}(\alpha_1,\,T_{amb})$ : angle measured by the sensor at  $\alpha_1$  and any temperature within  $T_{amb}$ 

This error comprises non-linearity and temperature drift related to the room temperature.

Programmable angle sensor

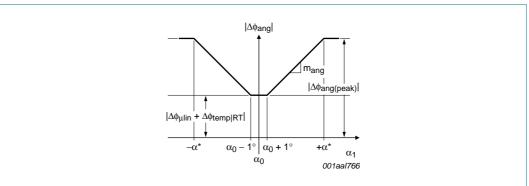


Fig 11. Envelope curve for the magnitude of angular error

Figure 11 shows the envelope curve for the magnitude of angular error  $|\Delta\phi_{ang}|$  versus  $\alpha_1$  for all angles  $\alpha_0$  and all temperatures  $T_{amb}$  within the ambient temperature range.  $|\Delta\phi_{ang}|$  has its minimum, if  $\alpha_1$  is in the range of  $\pm 1^\circ$  around  $\alpha_0$ . Here only the microlinearity error  $\Delta\phi_{\mu lin}$  and the temperature drift related to the room temperature  $|\Delta\phi_{temp}|_{RT}|$  occurs. If  $\alpha_1$  deviates from  $\alpha_0$  by more than  $1^\circ$  in either direction,  $|\Delta\phi_{ang}|$  can increase with a gradient defined by slope  $m_{ang}$ .

Angular error can be expressed by Equation 5 to Equation 8:

for 
$$|\alpha_1 - \alpha_0| \leq 1^\circ$$

$$\left| \Delta \phi_{ang} \right| = \left| \Delta \phi_{\mu lin} + \Delta \phi_{temp|RT} \right| \tag{5}$$

for 
$$1^{\circ} < |\alpha_1 - \alpha_0| < \alpha^*$$

$$|\Delta\phi_{ang}| = |\Delta\phi_{ulin} + \Delta\phi_{temp|RT}| + m_{ang} \times (|\alpha_1 - \alpha_0| - 1^\circ)$$
(6)

for 
$$|\alpha_1 - \alpha_0| \ge \alpha^*$$

$$\left|\Delta\phi_{ang}\right| = \sqrt{(\Delta\phi_{lin})^2 + (\Delta\phi_{temp|RT})^2} \tag{7}$$

with:

$$\alpha^* = \frac{\left|\Delta\phi_{\text{ang(peak)}}\right| - \left|\Delta\phi_{\mu lin} + \Delta\phi_{temp|RT}\right|}{m_{ang}} + \alpha_0 + I^{\circ}$$
(8)

## 13. Programming

#### 13.1 General description

The KMA210 provides an OWI to enable programming of the device which uses pin OUT/DATA bidirectionally.

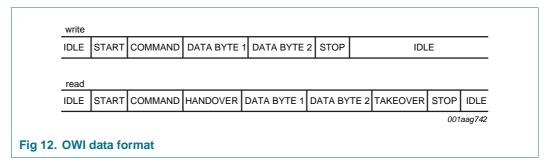
In general the device runs in analog output mode, the normal operation mode. This mode is configured by the embedded programming data and is started after a power-on reset once time  $t_{on}$  has elapsed. In this mode, the magnetic field angle is converted into the corresponding output voltage.

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Command mode has to be entered to enable programming. In this mode, the customer can adjust all required parameters (for example zero angle and angular range) to meet the application requirements. After enabling the internal charge pump and waiting for  $t_{cp}$  the data is stored in the non-volatile memory. After changing the contents of the memory, the checksum must be recalculated and written (see Section 13.4).

In order to enter the command mode, a specific command sequence must be sent after a power-on reset and during the time slot  $t_{cmd(ent)}$ . The external source used to send the command sequence must overdrive the output buffer of the KMA210. In doing so it provides current  $I_{od}$ .

During communication, the KMA210 is always the slave and the external programming hardware is the master. Figure 12 illustrates the structure of the OWI data format.



The master provides the start condition, which is a rising edge after a LOW level. Then a command byte which can be either a read or a write command is sent. Depending on the command, the master or the slave has to send the data immediately after the command sequence. In the case of a read command, an additional handover or takeover bit is inserted before and after the data bytes. Each communication must be closed with a stop condition driven by the master. If the slave does not receive a rising edge for a time longer than  $t_{to}$ , a time-out condition occurs. The bus is reset to the idle state and waits for a start condition and a new command. This can be used to synchronize the device regardless of the previous state.

All communication is based on this structure (see <u>Figure 12</u>), even for entering the command mode. In this case a special write command is required, followed by the command sequence (two data bytes). The customer can access the non-volatile memory, CTRL1, TESTCTRL0 and SIGNATURE registers (described in <u>Section 13.5</u>). Only a power-on reset will leave the command mode. A more detailed description of the programming is given in the next sections.

#### 13.2 Timing characteristics

As described in the previous section, a start and stop condition is necessary for communication. The LOW-level duration before the rising edge of the start condition is defined as  $t_{start}$ . The HIGH-level duration after the rising edge of the stop condition is defined as  $t_{stop}$ . These parameters, together with all other timing characteristics are shown in Table 14.

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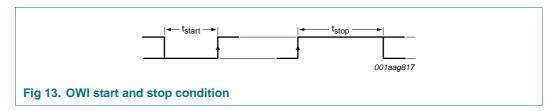
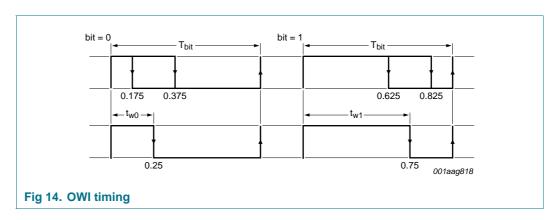


Figure 14 shows the coding of a single bit with a HIGH level of  $V_{IH}$  and a LOW level of  $V_{IL}$ . Here the pulse width  $t_{w1}$  or  $t_{w0}$  represents a logic 1 or a logic 0 of a full bit period  $T_{bit}$ , respectively.



#### 13.3 Sending and receiving data

The master has to control the communication during sending or receiving data. The command byte defines the region, address and type of command requested by the master. In case of a read command, an additional handover or takeover bit must be inserted before and after the two data bytes (see <a href="Figure 12">Figure 12</a>). However the OWI is a serial data transmission, whereas the Most Significant Byte (MSB) must be sent at first.

Table 16. Format of a command byte

| 7    | 6    | 5    | 4    | 3    | 2    | 1    | 0    |
|------|------|------|------|------|------|------|------|
| CMD7 | CMD6 | CMD5 | CMD4 | CMD3 | CMD2 | CMD1 | CMD0 |

Table 17. Command byte bit description

| Bit    | Symbol   | Description                      |
|--------|----------|----------------------------------|
| 7 to 5 | CMD[7:5] | region bits                      |
|        |          | 000 = 16-bit non-volatile memory |
|        |          | 001 to 011 = reserved            |
|        |          | 100 = 16-bit register            |
|        |          | 101 to 111 = reserved            |
| 4 to 1 | CMD[4:1] | address bits                     |
| 0      | CMD0     | read/write                       |
|        |          | 0 = write                        |
|        |          | 1 = read                         |

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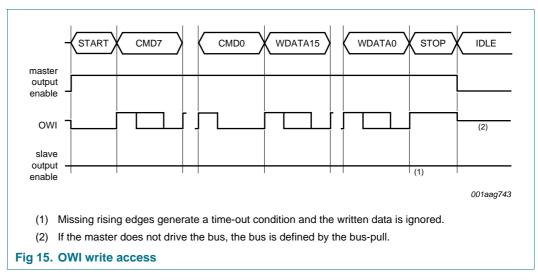
A more detailed description of all customer accessible registers is given in <u>Section 13.5</u>. Both default value and the complete command including the address and write or read request are also listed.

#### 13.3.1 Write access

To write data to the non-volatile memory, the internal charge pump must be enabled by setting bits CP\_CLOCK\_EN and WRITE\_EN and waiting for t<sub>cp</sub>. The following procedure must be performed:

- 1. Start condition: The master drives a rising edge after a LOW level
- 2. Command: The master sends a write command (CMD0 = 0)
- 3. Data: The master sends two data bytes
- 4. Stop condition: The master drives a rising edge after a LOW level

<u>Figure 15</u> shows the write access of the digital interface. The signal OWI represents the data on the bus from the master or slave. The signals: master output enable and slave output enable indicate when the master or the slave output is enabled or disabled, respectively.



**Note**: As already mentioned in Section 13.1, the command mode has to be entered using the write procedure. If command mode is not entered, communication is not possible and the sensor operates in normal operation mode. After changing an address, the time  $t_{prog}$  must elapse before changing another address. Finally the checksum must be recalculated and written, because the contents of the non-volatile memory have been changed (see Section 13.4).

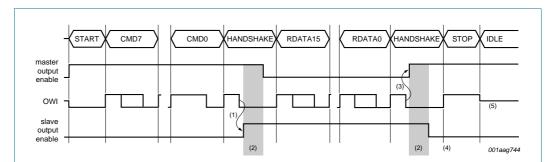
#### Programmable angle sensor

#### 13.3.2 Read access

To read data from the sensor, the following procedure must be performed:

- 1. Start condition: The master drives a rising edge after a LOW level
- 2. Command: The master sends a read command (CMD0 = 1)
- 3. Handover: The master sends a handover bit, that is a logic 0 and disables the output after a three-quarter bit period
- 4. Takeover: The slave drives a LOW level after the falling edge for t<sub>tko(slv)</sub>
- 5. Data: The slave sends two data bytes
- 6. Handover: The slave sends a handover bit, that is a logic 0 and disables the output after a three-quarter bit period
- 7. Takeover: The master drives a LOW level after the falling edge for t<sub>tko(mas)</sub>
- 8. Stop condition: The master drives a rising edge after a LOW level

<u>Figure 16</u> shows the read access of the digital interface. The signal OWI represents the data on the bus from the master or slave. The signals: master output enable and slave output enable indicate when the master or the slave output is enabled or disabled, respectively.



- (1) Duration of LOW level for slave takeover  $t_{tko(slv)}$ .
- (2) There is an overlap in the output enables of master and slave, because both drive a LOW level. However this ensures the independency from having a pull-up or pull-down on the bus. In addition it improves the EMC robustness, because all levels are actively driven.
- (3) Duration of LOW level for master takeover t<sub>tko(mas)</sub>.
- (4) If the master does not take over and a pull-up exists, the stop condition is generated by the pull-up. Otherwise a time-out is generated if there is a pull-down and the slave waits for a rising edge as start condition.
- (5) If the master does not drive the bus, the bus is defined by the bus-pull.

Fig 16. OWI read access

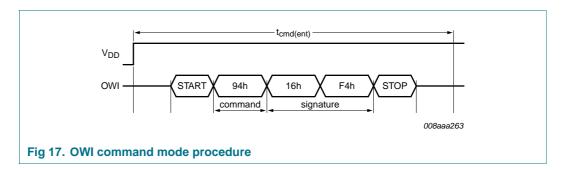
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#### 13.3.3 Entering the command mode

After a power-on reset, the sensor provides a time slot  $t_{cmd(ent)}$  for entering the command mode. A specific command sequence has to be sent (see Figure 17). If command mode is not entered, the sensor starts in the normal operation mode. However the signature can be written by the master if the sensor switches to diagnostic mode.

During the command mode sequence, the analog output is enabled. The external programming hardware has to overdrive the output with current I<sub>od</sub>. If command mode is activated, the analog output is disabled and pin OUT/DATA operates as a digital interface.



#### 13.4 Cyclic redundancy check

As already mentioned in <u>Section 7</u>, there is an 8-bit checksum for the non-volatile memory data. To calculate this value, the CRC needs to be generated with the MSB of the memory data word at first over all corresponding addresses in increasing order.

All addresses from 8h to Fh must be read out for calculating the checksum. The Least Significant Byte (LSB) of address Fh which contains the previous checksum must be overwritten with 0h before the calculation can be started.

Finally, the internal charge pump has to be enabled for programming by setting bits  $CP\_CLOCK\_EN$  and  $WRITE\_EN$  (see Section 13.5.1) and waiting for  $t_{cp}$ .

The generator polynomial for the calculation of the checksum is:

$$G(x) = x^8 + x^2 + x + 1 (9)$$

With a start value of FFh and the data bits are XOR at the x<sup>8</sup> point.

Programmable angle sensor

#### 13.4.1 Software example in C

```
#include <stdio.h.>
1
    // calc_crc accepts unsigned 16-bit data in data
3
     int calc crc(int crc, unsigned int data)
5
6
           const int gpoly = 0x107; // generator polynomial
                                      //index variable
7
           for (i = 15; i >= 0; i--)
9
                                      //shift left
                crc <<= 1;
10
11
                crc |= (int) ((data & (1u<<i))>>i);
12
                // XOR of with generator polynomial when MSB(9) = HIGH
13
                if (crc & 0x100) crc ^= gpoly;
14
15
           return crc;
16
17
     int main(void)
18
     {
           int crc, crc_res, i;
19
20
           // 8 LSB are CRC field filled with 0
           unsigned int data_seq[] = {0x0000, 0xFFC1, 0x0400, 0x0100,
2.1
                                      0x1300, 0x0000, 0x0000, 0x0000);
22
23
          // calculate checksum over all data
24
           crc = 0xFF;
                                      // start value of crc register
25
          printf("Address\tValue\n");
26
           for (i = 0; i <= 7; i++)
2.7
                printf("0x%1X\t0x%04X\n", i, data_seq[i]);
28
29
                crc = calc_crc(crc, data_seq[i]);
30
31
           crc_res = crc;
                                      // crc_res = 0xA9
32
           printf("\nChecksum\n0x%02X\n", crc_res);
33
           // check procedure for above data sequence
34
          crc = 0xFF;
35
          for (i = 0; i <= 6; i++)
36
                crc = calc_crc(crc, data_seq[i]);
37
          // last word gets crc inserted
38
          crc = calc_crc(crc, data_seg[i] | crc_res);
39
          printf("\nCheck procedure for data sequence: must be 0x00 is 0x%02X.\n",crc);
40
          return 1;
41
```

The checksum of this data sequence is A9h.

#### Programmable angle sensor

## 13.5 Registers

#### 13.5.1 Command registers

To enter the command mode, the signature given in <u>Table 18</u> must be written into the specific register using the OWI. This must be done as described in <u>Section 13.3.3</u>, with a write command, followed by the signature, but after a power-on reset and not later than  $t_{cmd(ent)}$ .

Table 18. Command registers

| Command write/read | Register  | Bit      | Access | Field           | Description   |
|--------------------|-----------|----------|--------|-----------------|---|
| 82h/83h            | CTRL1     | 15       | R      | IN_DIAG_MODE    | shows if there is a diagnostic condition present; this bit is not affected by the setting of register field FORCE_DIAG_OFF  |
|                    |           | 14       | W      | FORCE_DIAG_OFF  | force diagnostic mode off; default: 0b  |
|                    |           | 13       | -      | -               | reserved  |
|                    |           | 12       | R      | LOW_VOLTAGE_DET | low voltage condition detected  |
|                    |           | 11       | R/W    | CP_CLOCK_EN     | charge pump clock enabled (must be set after setting write enable signal for writing to non-volatile memory); default: 0b   |
|                    |           | 10 and 9 | -      | -               | reserved  |
|                    |           | 8        | R      | ERR_CORRECT     | single-bit error of non-volatile memory has been detected and corrected; updated every memory readout; remains set until the diagnostic condition disappears and a power-on reset is done |
|                    |           | 7        | R      | UNCORR_ERR      | double-bit error of non-volatile memory has been detected; updated every memory readout; remains set until the diagnostic condition disappears and a power-on reset is done               |
|                    |           | 6        | R      | MAGNET_LOSS_DET | magnet-loss detected; bit remains set until the diagnostic condition disappears and a power-on reset is done; magnet-loss detection must be enabled for entering diagnostic mode          |
|                    |           | 5        | R      | BROKEN_BOND_DET | broken bond wire detected; bit remains set until the diagnostic condition disappears and a power-on reset is done   |
|                    |           | 4        | R      | CRC_BAD         | checksum error detected; updated every start-up   |
|                    |           | 3 to 0   | -      | -               | reserved  |
| 94h/-              | SIGNATURE | 15 to 0  | W      | SIGNATURE       | write signature 16F4h within t <sub>cmd(ent)</sub> to enter command mode; see Section 13.3.3 for more details   |
| 96h/97h            | TESTCTRL0 | 15 to 12 | -      | -               | reserved  |
|                    |           | 11       | W      | WRITE_EN        | write enable signal; must be set before writing to non-volatile memory; default: 0b   |
|                    |           | 10 to 0  | -      | -               | reserved  |

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#### 13.5.2 Non-volatile memory registers

The device includes several internal registers which are used for customization and identification.

The initial signature allows read access to all areas but only write access to customer registers. Write accesses to reserved areas are ignored. Since these registers are implemented as non-volatile memory cells, writing to the registers needs a specific time  $t_{prog}$  after each write access to complete.

As there is no check for the programming time, the user must make sure no other accesses to the non-volatile memory are made during the programming cycle. The non-volatile memory must not be addressed during the time  $t_{prog}$ .

**Note**: Before data can be stored in the non-volatile memory, the internal charge pump has to be switched on for the programming duration by setting register CTRL1, bit 11 CP\_CLOCK\_EN and register TESTCTRL0, bit 11 WRITE\_EN. Register addresses 8h to Fh have to be read out and consulted to calculate the checksum.

Table 19. Non-volatile memory registers

| Address | Command write/read | Register         | Bit       | Description  | Default<br>MSB/LSB |
|---------|--------------------|------------------|-----------|--|--------------------|
| 0h      | -/01h              | reserved         | -         | addresses are reserved for calibration purposes  | <u>[1]</u>         |
| 1h      | -/03h              |                  |           |  |                    |
| 2h      | -/05h              |                  |           |  |                    |
| 3h      | -/07h              |                  |           |  |                    |
| 4h      | -/09h              |                  |           |  |                    |
| 5h      | -/0Bh              |                  |           |  |                    |
| 6h      | -/0Dh              |                  |           |  |                    |
| 7h      | -/0Fh              |                  |           |  |                    |
| 8h      | 10h/11h            | ZERO_ANGLE       | 15 to 0   | mechanical zero degree position; see Table 20  | 00h/00h            |
| 9h      | 12h/13h            | ANG_RNG_MULT_MSB | 15 to 6   | CLAMP_SW_ANGLE; when the measured angle is bigger than CLAMP_SW_ANGLE the output switches to CLAMP_LO for a positive slope; see Table 25 | FFh/C1h            |
|         |                    |                  | 5 to 0    | ANG_RNG_MULT_MSB; most significant bits of the angular range multiplicator; see <u>Table 23</u>  |                    |
| Ah      | 14h/15h            | ANG_RNG_MULT_LSB | 15 and 14 | DIAGNOSTIC_LEVEL; diagnostic level behavior of the analog output; see Table 24   | 04h/00h            |
|         |                    |                  |           | <b>00b</b> — active LOW (in lower diagnostic range) with driver strength of the analog output  |                    |
|         |                    |                  |           | <b>01b</b> — active HIGH (in upper diagnostic range) with driver strength of the analog output   |                    |
|         |                    |                  |           | 10b — reserved   |                    |
|         |                    |                  |           | 11b — reserved   |                    |
|         |                    |                  | 13        | SLOPE_DIR; slope of analog output  |                    |
|         |                    |                  |           | <b>0b</b> — rising (not inverted)  |                    |
|         |                    |                  |           | 1b — falling (inverted)  |                    |
|         |                    |                  | 12 to 0   | ANG_RNG_MULT_LSB; least significant bits of the angular range multiplicator  |                    |

#### Programmable angle sensor

Table 19. Non-volatile memory registers ...continued

| Address | Command write/read | Register  | Bit       | Description  | Default<br>MSB/LSB |
|---------|--------------------|-----------|-----------|--|--------------------|
| Bh      | 16h/17h            | CLAMP_LO  | 15        | <b>0b</b> — reserved                                       | 01h/00h            |
|         |                    |           | 14 and 13 | undefined <sup>[2]</sup>                                   |                    |
|         |                    |           | 12 to 0   | lower clamping level; see <u>Table 21</u>                  |                    |
| Ch      | 18h/19h            | CLAMP_HI  | 15 to 13  | undefined[2]   | 13h/00h            |
|         |                    |           | 12 to 0   | upper clamping level; see Table 22                         |                    |
| Dh      | 1Ah/1Bh            | ID_LO     | 15 to 0   | lower 16 bits of identification code                       | 00h/00h            |
| Eh      | 1Ch/1Dh            | ID_HI     | 15 to 0   | upper 16 bits of identification code                       | 00h/00h            |
| Fh      | 1Eh/1Fh            | CTRL_CUST | 15        | LOCK; irreversible write protection of non-volatile memory | 00h/[1]            |
|         |                    |           |           | 1b — enabled   |                    |
|         |                    |           | 14 to 8   | MAGNET_LOSS; magnet-loss detection                         |                    |
|         |                    |           |           | 00h — disabled   |                    |
|         |                    |           |           | <b>49h</b> — enabled                                       |                    |
|         |                    |           | 7 to 0    | CRC; checksum (see Section 13.4)                           |                    |

<sup>[1]</sup> Variable and individual for each device.

#### Table 20. ZERO\_ANGLE - mechanical zero degree position (address 8h) bit allocation

Data format: unsigned fixed point; resolution: 2<sup>-16</sup>.

| Bit   | 15  | 14  | 13  | 12  | 11  | 10  | 9   | 8   | 7   | 6    | 5    | 4    | 3    | 2    | 1    | 0    |
|-------|-----|-----|-----|-----|-----|-----|-----|-----|-----|------|------|------|------|------|------|------|
| Value | 2-1 | 2-2 | 2-3 | 2-4 | 2-5 | 2-6 | 2-7 | 2-8 | 2-9 | 2-10 | 2-11 | 2-12 | 2-13 | 2-14 | 2-15 | 2-16 |

Mechanical angular range  $0000h = 0^{\circ}$  to FFFFh =  $180^{\circ} - 1$  LSB.

#### Examples:

- Mechanical zero angle 0° = 0000h
- Mechanical zero angle 10° = 0E38h
- Mechanical zero angle 45° = 4000h

#### Table 21. CLAMP\_LO - lower clamping level (address Bh) bit allocation

Data format: unsigned integer (DAC values 256 to 4864); resolution: 20.

| Bit   | 15 | 14           | 13           | 12              | 11              | 10              | 9              | 8              | 7  | 6              | 5              | 4       | 3                     | 2                     | 1  | 0  |
|-------|----|--------------|--------------|-----------------|-----------------|-----------------|----------------|----------------|----|----------------|----------------|---------|-----------------------|-----------------------|----|----|
| Value | 0  | U <u>[1]</u> | U <u>[1]</u> | 2 <sup>12</sup> | 2 <sup>11</sup> | 2 <sup>10</sup> | 2 <sup>9</sup> | 2 <sup>8</sup> | 27 | 2 <sup>6</sup> | 2 <sup>5</sup> | $2^{4}$ | <b>2</b> <sup>3</sup> | <b>2</b> <sup>2</sup> | 21 | 20 |

[1] Undefined; must be written as zero for default and may return any value when read.

Values 0 to 255 are reserved. It is not permitted to use such values.

#### Examples:

- 100 %V<sub>DD</sub> = 5120 (reserved)
- 10 %V<sub>DD</sub> = 512
- 5 %V<sub>DD</sub> = 256

KMA210

<sup>[2]</sup> Undefined; must be written as zero for default.

#### Programmable angle sensor

Table 22. CLAMP\_HI - upper clamping level (address Ch) bit allocation

Data format: unsigned integer (DAC values 256 to 4864); resolution: 20.

| Bit   | 15           | 14           | 13           | 12              | 11              | 10              | 9              | 8              | 7  | 6              | 5              | 4              | 3                     | 2  | 1  | 0  |
|-------|--------------|--------------|--------------|-----------------|-----------------|-----------------|----------------|----------------|----|----------------|----------------|----------------|-----------------------|----|----|----|
| Value | U <u>[1]</u> | U <u>[1]</u> | U <u>[1]</u> | 2 <sup>12</sup> | 2 <sup>11</sup> | 2 <sup>10</sup> | 2 <sup>9</sup> | 2 <sup>8</sup> | 27 | 2 <sup>6</sup> | 2 <sup>5</sup> | 2 <sup>4</sup> | <b>2</b> <sup>3</sup> | 22 | 21 | 20 |

[1] Undefined; must be written as zero for default and may return any value when read.

Values 4865 to 5120 are reserved. It is not permitted to use such values.

#### Examples:

- 100 %V<sub>DD</sub> = 5120 (reserved)
- 95 %V<sub>DD</sub> = 4864
- 90 % $V_{DD} = 4608$

Table 23. ANG\_RNG\_MULT\_MSB - most significant bits of angular range multiplicator (address 9h) bit allocation Data format: unsigned fixed point; resolution: 2<sup>-1</sup>.

| Bit   | 15             | 14 | 13 | 12 | 11 | 10 | 9 | 8              | 7              | 6              | 5              | 4  | 3   | 2 | 1 | 0 |
|-------|----------------|----|----|----|----|----|---|----------------|----------------|----------------|----------------|----|-----|---|---|---|
| Value | CLAMP_SW_ANGLE |    |    |    |    |    |   | 2 <sup>4</sup> | 2 <sup>3</sup> | 2 <sup>2</sup> | 2 <sup>1</sup> | 20 | 2-1 |   |   |   |

$$ANG_{\text{RNG\_MULT}} = \frac{\text{CLAMP\_HI} - \text{CLAMP\_LO}}{8192} \times \frac{180^{\circ}}{ANGULAR \text{ RANGE}}$$
 (10)

#### Examples:

• 
$$ANG_RNG_MULT = \frac{4864 - 256}{8192} \times \frac{180^{\circ}}{180^{\circ}} = 0.5625$$

• 
$$ANG_RNG_MULT = \frac{4864 - 256}{8192} \times \frac{180^{\circ}}{90^{\circ}} = 1.125$$

Table 24. ANG\_RNG\_MULT\_LSB - least significant bits of angular range multiplicator (address Ah) bit allocation Data format: unsigned fixed point; resolution: 2<sup>-14</sup>.

|       |   |           |              |     |     |     |     |     |          |     |     |      |      |      |      | 0    |
|-------|---|-----------|--------------|-----|-----|-----|-----|-----|----------|-----|-----|------|------|------|------|------|
| Value | V | <u>1]</u> | V <u>[1]</u> | 2-2 | 2-3 | 2-4 | 2-5 | 2-6 | $2^{-7}$ | 2-8 | 2-9 | 2-10 | 2-11 | 2-12 | 2-13 | 2-14 |

[1] Variable; depending on the setting of diagnostic level and slope of analog output.

$$ANG_{\text{RNG\_MULT}} = \frac{\text{CLAMP\_HI} - \text{CLAMP\_LO}}{8192} \times \frac{180^{\circ}}{ANGULAR \text{ RANGE}}$$
(11)

#### Table 25. CLAMP\_SW\_ANGLE - clamp switch angle (address 9h) bit allocation

Data format: unsigned fixed point; resolution:  $2^{-10}$ .

| Bit   | 15  | 14  | 13  | 12  | 11  | 10  | 9   | 8   | 7   | 6    | 5 | 4   | 3     | 2     | 1   | 0 |
|-------|-----|-----|-----|-----|-----|-----|-----|-----|-----|------|---|-----|-------|-------|-----|---|
| Value | 2-1 | 2-2 | 2-3 | 2-4 | 2-5 | 2-6 | 2-7 | 2-8 | 2-9 | 2-10 |   | ANG | _RNG_ | MULT_ | MSB |   |

Mechanical angular range  $0000h = 0^{\circ}$  to 3FFh =  $180^{\circ} - 1$  LSB.

$$CLAMP\_SW\_ANGLE = \frac{1}{2} \times \left(1 + \frac{CLAMP\_HI - CLAMP\_LO}{8192} \times \frac{1}{ANG\_RNG\_MULT}\right)$$
 (12)

If the magnetic field angle is larger than the CLAMP\_SW\_ANGLE, the output switches to CLAMP\_LO for a positive slope. The value of CLAMP\_SW\_ANGLE can be calculated from other non-volatile memory constants but must be programmed.

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#### Programmable angle sensor

## 14. Electromagnetic compatibility

EMC is verified in an independent and certified test laboratory.

#### 14.1 Emission (CISPR 25)

Tests according to CISPR 25 were fulfilled.

#### 14.1.1 Conducted radio disturbance

Test of the device according to CISPR 25, third edition (2008-03), Chapter 6.2.

Classification level: 5.

#### 14.1.2 Radiated radio disturbance

Test of the device according to CISPR 25, third edition (2008-03), Chapter 6.4.

Classification level: 5 (without addition of 6 dB in FM band).

# 14.2 Radiated disturbances (ISO 11452-1 third edition (2005-02), ISO 11452-2, ISO 11452-4 and ISO 11452-5)

The common understanding of the requested function is that an effect is tolerated as described in <u>Table 26</u> during the disturbance. The reachable values are setup dependent and may differ from the final application.

Table 26. Failure condition for radiated disturbances

| Parameter  | Comment   | Min | Max  | Unit             |
|--|---|-----|------|------------------|
| Variation of output signal in analog output mode | value measured relative to the output at test start | -   | ±0.9 | %V <sub>DD</sub> |

#### 14.2.1 Absorber lined shielded enclosure

Tests according to ISO 11452-2, second edition (2004-11), were fulfilled.

Test level: 200 V/m; extended up to 10 GHz.

State: A.

#### 14.2.2 Bulk-current injection

Tests according to ISO 11452-4, third edition (2005-04), were fulfilled.

Test level: 200 mA.

State: A.

#### **14.2.3** Strip line

Tests according to ISO 11452-5, second edition (2002-04), were fulfilled.

Test level: 200 V/m; extended up to 1 GHz.

State: A.

#### Programmable angle sensor

#### 14.2.4 Immunity against mobile phones

Tests according to ISO 11452-2, second edition (2004-11), were fulfilled.

State: A.

Definition of Global System for Mobile Communications (GSM) signal:

- Pulse modulation: per GSM specification (217 Hz; 12.5 % duty cycle)
- Modulation grade: ≥ 60 dB
- Sweep: linear 800 MHz to 3 GHz (duration 10 s at 890 MHz, 940 MHz and 1.8 GHz band)
- Antenna polarization: vertical, horizontal
- Field strength: 200 V/m during on-time [calibration in Continuous Wave (CW)]

In deviation of ISO 11452-2 a GSM signal (definition see above) instead of an AM signal was used.

# 14.3 Electrical transient transmission by capacitive coupling [ISO 7637-3, second edition (2007-07)]

The common understanding of the requested function is that an effect is tolerated as described in Table 27 during the disturbance.

Table 27. Failure condition for electrical transient transmission

| Parameter                                       | Comment   | Min | Max  | Unit             |
|---|---|-----|------|------------------|
| Variation of output signal in analogoutput mode | y value measured relative to the output at test start | -   | ±0.9 | %V <sub>DD</sub> |

Tests according to ISO 7637-3 were fulfilled.

Test level: IV (for 12 V electrical system).

Classification level: B for pulse Fast a, B for pulse Fast b.

Programmable angle sensor

## 15. ElectroStatic Discharge (ESD)

#### 15.1 Human body model (AEC-Q100-002)

The KMA210 must not be damaged at 8 kV, according to the human body model at 100 pF and 1.5 k $\Omega$ . This protection is ensured at all external pins (OUT/DATA, V<sub>DD</sub> and GND).

Classification level: H3B.

Furthermore, all interconnects (pins between package head and package body) must not be damaged at 2 kV.

Classification level: H2.

#### 15.2 Human metal model (ANSI/ESD SP5.6-2009)

The KMA210 must not be damaged at 8 kV, according to the human metal model at 150 pF and 330  $\Omega$  inside the ESD gun. This test utilizes waveforms of the IEC 61000-4-2 standard on component level. The contact discharge will be applied in an unsupplied state at pins OUT/DATA and  $V_{DD}$  referred to GND which is connected directly to the ground plane.

Test setup: A.

Test level: 5.

#### 15.3 Machine model (AEC-Q100-003)

The KMA210 must not be damaged at 400 V, according to the machine model. This protection is ensured at all external pins (OUT/DATA, V<sub>DD</sub> and GND).

Classification level: M4.

Furthermore, all interconnects (pins between package head and package body) must not be damaged at 200 V.

Classification level: M3.

All pins have latch-up protection.

#### 15.4 Charged-device model (AEC-Q100-011)

The KMA210 must not be damaged at 750 V, according to the charged-device model. This protection is ensured at all external pins (OUT/DATA, V<sub>DD</sub> and GND).

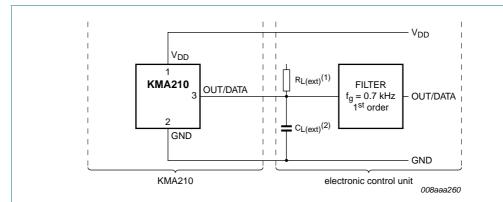
Classification level: C4.

Furthermore, all interconnects (pins between package head and package body) must not be damaged at 500 V.

Classification level: C3B.

#### Programmable angle sensor

## 16. Application information



- (1) Power-loss detection is only possible with a load resistance within the specified range connected to the supply or ground line.
- (2) The load capacitance between ground and analog output can be used to improve the electromagnetic immunity of the device. A blocking capacitance to suppress noise on the supply line of the device is integrated into the package and thus not required externally.

Fig 18. Application diagram of KMA210

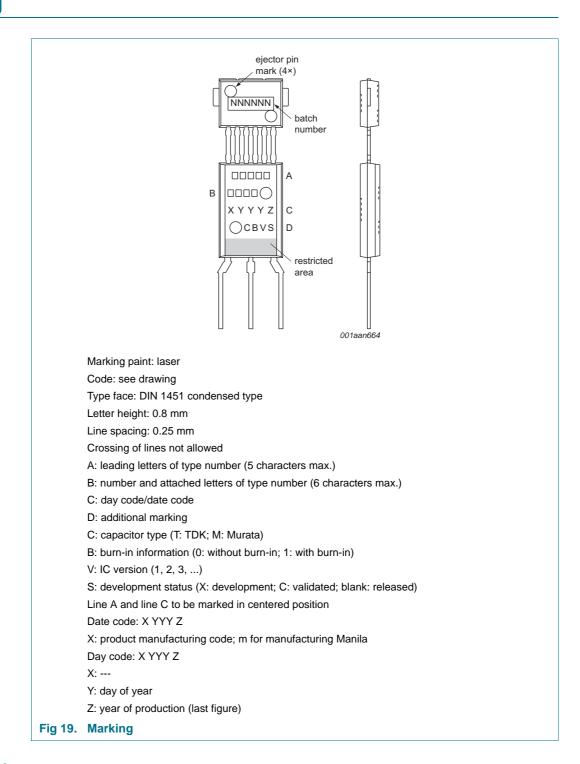
#### 17. Test information

#### 17.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q100 Rev-G - Failure mechanism based stress test qualification for integrated circuits*, and is suitable for use in automotive applications.

#### Programmable angle sensor

## 18. Marking



#### 19. Terminals

Lead frame material: CuZr with 99.9 % Cu and 0.1 % Zr.

#### Programmable angle sensor

## 20. Package outline

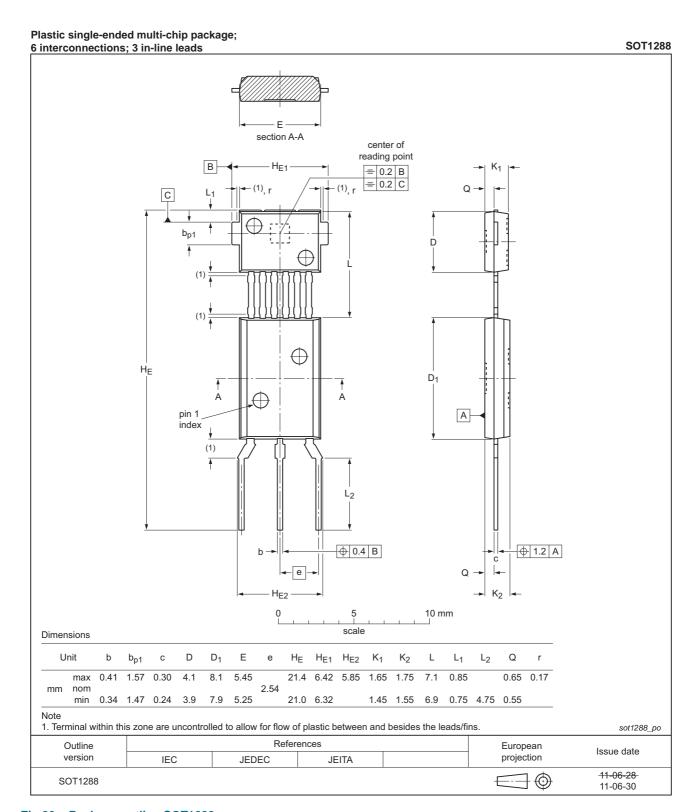


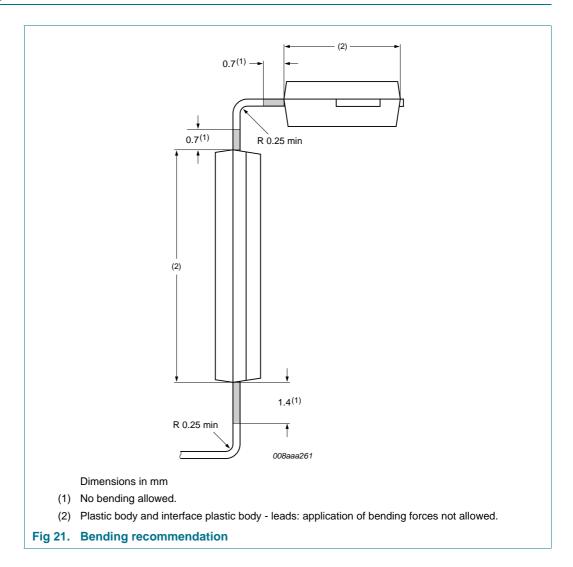
Fig 20. Package outline SOT1288

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Programmable angle sensor

## 21. Handling information



## 22. Solderability information

The solderability qualification is according to AEC-Q100 Rev-G. Recommended soldering process for leaded devices is wave soldering. The maximum soldering temperature is 260 °C for maximum 5 s. Device terminals shall be compatible with laser and electrical welding. The device is reflow capable.

## Programmable angle sensor

## 23. Revision history

#### Table 28. Revision history

| Document ID    | Release date   | Data sheet status                                       | Change notice | Supersedes |  |  |  |  |  |  |
|----------------|--|---|---------------|------------|--|--|--|--|--|--|
| KMA210 v.2     | 20111207   | Product data sheet                                      | -             | KMA210 v.1 |  |  |  |  |  |  |
| Modifications: | <u>Table 6 "Diagnostic behavior"</u> : Power-loss duration changed |   |               |            |  |  |  |  |  |  |
|                | Section 19 <sup>6</sup>  | Section 19 "Terminals": Lead finish information removed |               |            |  |  |  |  |  |  |
| KMA210 v.1     | 20110630   | Product data sheet                                      | -             | -          |  |  |  |  |  |  |

#### Programmable angle sensor

## 24. Legal information

#### 24.1 Data sheet status

| Document status[1][2]          | Product status[3] | Definition  |
|--------------------------------|-------------------|---|
| Objective [short] data sheet   | Development       | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification     | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production        | This document contains the product specification.                                     |

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#### Programmable angle sensor

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**KMA210 NXP Semiconductors** 

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